Please submit this invention report at [https://imt.ad.here.com](https://imt.ad.here.com/), and if you have difficulties in submitting the invention report, you can email it to [ipr.inventions@here.com](mailto:ipr.inventions@here.com).

# TITLE OF THE INVENTION:

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# Inventor details

Please note that each person who made a contribution to the invention must be named as an inventor in this section.

(There needs to be a separate agreement between HERE and the employer of the external inventor (please specify the details below in the “Joint inventions” section).

Please consult the HERE Patenting Team with additional questions.

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| --- | --- | --- | --- | --- |
| **HERE Inventor name**  (Surname, given name(s); Chinese inventors, please add your name also in Chinese characters and identify which name is your family name and your given name(s)) | **HERE ID** | **Home address\* and personal email**  **MANDATORY** | **Nationality\*\*** | **Employer at the time of the invention** |
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| --- | --- | --- | --- |
| **Non-HERE Inventor(s)**  (Surname, given name(s); Chinese inventor, please add your name also in Chinese characters and identify which name is your family name and which your given name(s)) | **Home address\* and personal email**  **MANDATORY** | **Nationality\*\*** | **Employer** |
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\*Your home address and personal email address are necessary for the HERE Patenting team to keep on-file for two reasons. First, if you separate from HERE, the Patenting team will need a way to communicate with you (e.g., for patent payments, questions, etc.). Also, the home address is oftentimes part of patent application filings; however, you should know that your home address will be used in a potential patent application and may become public via some patent offices. If you do not want your home address to be used in a potential patent application, please give your office address, indicating the HERE entity and that the address is your office address.

\*\*Nationality information from inventors is needed for patent applications in certain countries.

# Joint inventions (with other company or subcontractors)

|  |  |
| --- | --- |
| Company name, address, email & contact person: |  |
| Project and/or agreement number and link to the agreement: |  |
| HERE contact person: |  |

# Has the idea already been discussed with someone in the HERE Patenting team? For example, have you had an informal discussion about the idea with a patent engineer/attorney or has a patent engineer/attorney made a pre-screening search on your idea? If yes, please indicate the name of the person.

[

# Field of technology and background of the invention Describe the technology and the areas of use the invention relates to. Provide general background knowledge that is required to understand the framework of the invention. Leave a description of a problem to be solved and the invention in the subsequent paragraphs.

[

# Problem Describe the problem that the invention solves or the situation that the invention improves. Mainly concentrate on the technical aspects of the problem or the situation.

[

# Current state of technology Describe how the problem was solved earlier or the current state of technology that is causing the problem described above in section 2. Please state also the source of prior art accurately (literature references, patent numbers, URLs etc). In case of a non-patent reference, please attach a copy of it in your submission, if possible.

[

# Brief summary of the invention Crystallize the invention in few sentences. Concentrate on technical features and describe on a general level how the invention is different from the prior art.

[

# Detailed description and implementation of the invention Describe exemplary technical implementations in detail with alternatives, including at least the implementation you consider the best. Describe the crucial elements in detail. Include figures, flowcharts, signalling diagrams, device, architecture and UI presentations etc. Spell out any abbreviations used.

[

# Advantages and disadvantages Describe how the invention improves earlier solutions. If you are aware of any technical advantages or disadvantages, please state them here.

[

# Supervision Explain how we can (if possible) recognize if a competitor is using the same product/feature.

[

The invention is:

* Easy to detect (e.g., obvious, use of the invention can be noticed in everyday use)
* Somewhat difficult to detect (e.g., requires test tools, opening of product, use of SW development kit)
* Difficult to detect (e.g., requires reverse-engineering of SW object code or IC operation)

# Implementation, standard relevance, experts and further comments You can indicate in this section if you know about plans to implement the invention in products or to contibute to a standard, if you consider the invention to require further development, know of a related earlier invention report in HERE by you or others, or have any additional information that you think may otherwise affect the decision process. Please list some experts capable of commenting on the invention, if known.

[

1. **Publication/Public use/Sale**  
   if the invention is becoming public in any way, please describe the exact way and details of the publication: what will be disclosed, how and when. For example, submission of standardization contributions, scientific papers, conference abstract, theses or papers written for a degree and commercial brochures and offers for sale may be considered as publication. Also, any use in a product that is publicly available or disclosure (written or oral) to another company without a non-disclosure agreement (NDA) is considered to be a publication.

In case of urgent publication, please contact the HERE Patenting Team before publishing the invention.

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**On behalf of all the inventors, this is to confirm and acknowledge that:**

* I am/we are the sole/and original inventor(s) of this invention.
* The company may, by virtue of applicable legislation, be entitled to full or partial rights to the invention.
* I/We acknowledge my/our obligation to sign as inventor(s) all documents that may be required for protecting the invention in different countries.
* I/We hereby give my/our consent for the personal data included in this invention report to be transferred, also to countries outside the European Economic Area to the external associates of HERE to be processed and used in relation to drafting, filing and/or prosecuting the patent and/or utility model application(s) based on this invention report. Such data may become publicly available when patent/utility model application is published and/or the patent/utility model granted/issued.
* I/We acknowledge and agree that English is the company language and that all communications, notifications and agreements concerning the invention may be made in the English language.
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* I/We have accessed and read the HERE Group Guidelines for Employee Inventions and acknowledge that they are applicable to this invention.
* HERE Invention Reports are to be filed electronically. In addition, the Inventor may wish or may be requested to file also a paper copy, signed by the inventor(s).
* The acceptance of the above statements and terms is indicated in the electronically filed HERE Invention Submission via the Invention Management Tool. Alternatively, the inventor(s) may indicate accecptance of these terms via [ipr.inventions@here.com](mailto:ipr.inventions@here.com), or send a signed invention report to HERE North America, LLC, 425 West Randolph Street, Patenting Team, Attention Debra Huffman, Chicago, Illinois 60606.
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Date : [ ]

**Signature(s) of Inventor(s):**

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Unless the inventor requests that this Invention Report is responded to within four (4) months from the date that it is received, or such other period as the mandatory provisions of the applicable local law may otherwise require, the inventor consents to the right of the employer to use a reasonable period of time for the evaluation of the invention. A reasonable period of time may exceed four (4) months.

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